- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Latch-Up Performance Exceeds 250 mA Per JESD 17

#### description/ordering information

The 'AHC540 octal buffers/drivers are ideal for driving bus lines or buffer memory address registers. These devices feature inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

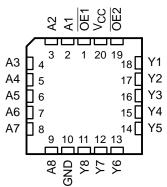
The 3-state control gate is a two-input AND gate with active-low inputs so that, if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all corresponding outputs are in the high-impedance state. The outputs provide inverted data when they are not in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| SN54AHC540 J OR W PACKAGE                    |
|--|
| SN74AHC540 DB, DGV, DW, N, NS, OR PW PACKAGE |
| (TOP VIEW)                                   |

|     | (        | ,           |                       |
|-----|----------|-------------|-----------------------|
| OE1 | 1        | $\cup_{20}$ | <u>v<sub>cc</sub></u> |
| A1  | 2        | 19          | 0E2                   |
| A2  | 3        | 18          | ] Y1                  |
| A3  | 4        | 17          | ] Y2                  |
| A4  | 5        | 16          | ] Y3                  |
| A5  | 6        | 15          | ] Y4                  |
| A6  | 7        | 14          | ] Y5                  |
| A7  | 8        | 13          | ] Y6                  |
| A8  | 9        | 12          | ] Y7                  |
| GND | 10       | 11          | ] Y8                  |
|     | <u> </u> |             | I                     |

SN54AHC540 . . . FK PACKAGE (TOP VIEW)



#### **ORDERING INFORMATION**

| T <sub>A</sub> | PACKA       | GE†                        | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|-------------|----------------------------|--------------------------|---------------------|
|                | PDIP – N    | Tube                       | SN74AHC540N              | SN74AHC540N         |
|                | SOIC - DW   | Tube                       | SN74AHC540DW             | AHC540              |
|                | 3010 - 010  | Tape and reel              | SN74AHC540DWR            | AI 10340            |
| -40°C to 85°C  | SOP – NS    | Tape and reel              | SN74AHC540NSR            | AHC540              |
| 40 0 10 00 0   | SSOP – DB   | Tape and reel              | SN74AHC540DBR            | HA540               |
|                | TSSOP – PW  | Tube                       | SN74AHC540PW             | HA540               |
|                | 1330F - FW  | Tape and reel              | SN74AHC540PWR            | HA340               |
|                | TVSOP – DGV | Tape and reel SN74AHC540DG |                          | HA540               |
|                | CDIP – J    | Tube                       | SNJ54AHC540J             | SNJ54AHC540J        |
| –55°C to 125°C | CFP – W     | Tube                       | SNJ54AHC540W             | SNJ54AHC540W        |
|                | LCCC – FK   | Tube                       | SNJ54AHC540FK            | SNJ54AHC540FK       |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

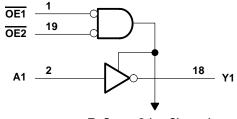


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| FU | N | СТ | ION | T/ | AB | LE |
|----|---|----|-----|----|----|----|
|    |   |    |     |    |    |    |

|     | (each bu | tter/ari | ver)   |
|-----|----------|----------|--------|
|     | INPUTS   |          | OUTPUT |
| OE1 | OE2      | Α        | Y      |
| L   | L        | L        | Н      |
| L   | L        | н        | L      |
| Н   | Х        | Х        | Z      |
| Х   | Н        | Х        | Z      |

#### logic diagram (positive logic)



To Seven Other Channels

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

| Supply voltage range, $V_{CC}$<br>Input voltage range, $V_I$ (see Note 1)<br>Output voltage range, $V_O$ (see Note 1)<br>Input clamp current, $I_{IK}$ ( $V_I < 0$ )<br>Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$<br>Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )<br>Continuous current through $V_{CC}$ or GND<br>Package thermal impedance, $\theta_{JA}$ (see Note 2): | c)<br>: DB package<br>DGV package<br>DW package<br>N package<br>NS package<br>PW package | $\begin{array}{cccc} -0.5 \mbox{ V to 7 V} \\0.5 \mbox{ V to V}_{CC} + 0.5 \mbox{ V} \\20 \mbox{ mA} \\ \pm 20 \mbox{ mA} \\ \pm 25 \mbox{ mA} \\ \pm 25 \mbox{ mA} \\ \pm 75 \mbox{ mA} \\ 70^{\circ}\mbox{C/W} \\ 92^{\circ}\mbox{C/W} \\ 69^{\circ}\mbox{C/W} \\ 60^{\circ}\mbox{C/W} \\ 83^{\circ}\mbox{C/W} \end{array}$ |
|--|--|---|
| Storage temperature range, T <sub>stg</sub>  |  | –65°C to 150°C  |

<sup>+</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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#### recommended operating conditions (see Note 3)

|                       |                                    |  | SN54A | SN54AHC540 |      | HC540 |            |
|-----------------------|------------------------------------|--|-------|------------|------|-------|------------|
|                       |                                    |  | MIN   | MAX        | MIN  | MAX   | UNIT       |
| VCC                   | Supply voltage                     |  | 2     | 5.5        | 2    | 5.5   | V          |
|                       |                                    | $V_{CC} = 2 V$                             | 1.5   |            | 1.5  |       |            |
| VIH                   | High-level input voltage           | $V_{CC} = 3 V$                             | 2.1   |            | 2.1  |       | V          |
|                       |                                    | $V_{CC} = 5.5 V$                           | 3.85  |            | 3.85 |       |            |
|                       |                                    | $V_{CC} = 2 V$                             |       | 0.5        |      | 0.5   |            |
| $V_{IL}$              | Low-level input voltage            | $V_{CC} = 3 V$                             |       | 0.9        |      | 0.9   | V          |
|                       |                                    | V <sub>CC</sub> = 5.5 V                    |       | 1.65       |      | 1.65  |            |
| VI                    | Input voltage                      | -  | 0     | 5.5        | 0    | 5.5   | V          |
| VO                    | Output voltage                     |  | 0     | VCC        | 0    | VCC   | V          |
|                       |                                    | $V_{CC} = 2 V$                             |       | -50        |      | -50   | μA         |
| ЮН                    | High-level output current          | $V_{CC}$ = 3.3 V ± 0.3 V                   |       | -4         |      | -4    | <b>~</b> ^ |
|                       |                                    | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$   |       | -8         |      | -8    | mA         |
|                       |                                    | $V_{CC} = 2 V$                             |       | 50         |      | 50    | μA         |
| IOL                   | Low-level output current           | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |       | 4          |      | 4     |            |
|                       |                                    | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$   |       | 8          |      | 8     | mA         |
| A # / A               | Innut transition rise or fall rate | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |       | 100        |      | 100   | 20/1       |
| $\Delta t / \Delta v$ | Input transition rise or fall rate | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$   |       | 20         |      | 20    | ns/V       |
| TA                    | Operating free-air temperature     |  | -55   | 125        | -40  | 85    | °C         |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS                                   | Vee          | Т    | ן = 25°C | ;     | SN54A | HC540 | SN74AI | HC540 | UNIT |
|-----------|---|--------------|------|----------|-------|-------|-------|--------|-------|------|
| PARAMETER | TEST CONDITIONS                                   | Vcc          | MIN  | TYP      | MAX   | MIN   | MAX   | MIN    | MAX   | UNIT |
|           |   | 2 V          | 1.9  | 2        |       | 1.9   |       | 1.9    |       |      |
|           | I <sub>OH</sub> = -50 μA                          | 3 V          | 2.9  | 3        |       | 2.9   |       | 2.9    |       |      |
| ∨он       |   | 4.5 V        | 4.4  | 4.5      |       | 4.4   |       | 4.4    |       | V    |
|           | I <sub>OH</sub> = -4 mA                           | 3 V          | 2.58 |          |       | 2.48  |       | 2.48   |       |      |
|           | I <sub>OH</sub> = -8 mA                           | 4.5 V        | 3.94 |          |       | 3.8   |       | 3.8    |       |      |
|           |   | 2 V          |      |          | 0.1   |       | 0.1   |        | 0.1   |      |
|           | I <sub>OL</sub> = 50 μA                           | 3 V          |      |          | 0.1   |       | 0.1   |        | 0.1   |      |
| VOL       |   | 4.5 V        |      |          | 0.1   |       | 0.1   |        | 0.1   | V    |
|           | I <sub>OL</sub> = 4 mA                            | 3 V          |      |          | 0.36  |       | 0.5   |        | 0.44  |      |
|           | I <sub>OL</sub> = 8 mA                            | 4.5 V        |      |          | 0.36  |       | 0.5   |        | 0.44  |      |
| lj        | V <sub>I</sub> = 5.5 V or GND                     | 0 V to 5.5 V |      |          | ±0.1  |       | ±1*   |        | ±1    | μA   |
| loz†      | $V_{O} = V_{CC}$ or GND,<br>VI (OE) = VIL or VIH  | 5.5 V        |      |          | ±0.25 |       | ±2.5  |        | ±2.5  | μA   |
| ICC       | $V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$ | 5.5 V        |      |          | 4     |       | 40    |        | 40    | μA   |
| Ci        | $V_{I} = V_{CC}$ or GND                           | 5 V          |      | 2        | 10    |       |       |        | 10    | pF   |
| Co        | $V_{O} = V_{CC}$ or GND                           | 5 V          |      | 4        |       |       |       |        |       | pF   |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 V$ .

<sup>†</sup> For I/O pins, the parameter I<sub>OZ</sub> includes the input leakage current.



### SN54AHC540, SN74AHC540 **OCTAL BUFFÉRS/DRIVERS** WITH 3-STATE OUTPUTS

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

| 00                 | •       |          | , ,                       | 5              | ,        |       |       |       |       |       |      |
|--------------------|---------|----------|---------------------------|----------------|----------|-------|-------|-------|-------|-------|------|
| DADAMETER          | FROM    | то       | LOAD                      | Τ <sub>4</sub> | λ = 25°C | ;     | SN54A | HC540 | SN74A | HC540 | UNIT |
| PARAMETER          | (INPUT) | (OUTPUT) | CAPACITANCE               | MIN            | TYP      | MAX   | MIN   | MAX   | MIN   | MAX   | UNIT |
| <sup>t</sup> PLH   | А       | Y        | C <sub>I</sub> = 15 pF    |                | 4.8*     | 7*    | 1*    | 8.5*  | 1     | 8.5   | 20   |
| <sup>t</sup> PHL   | A       | T        |                           |                | 4.8*     | 7*    | 1*    | 8.5*  | 1     | 8.5   | ns   |
| <sup>t</sup> PZH   | <u></u> | Y        | C <sub>L</sub> = 15 pF    |                | 6.8*     | 10.5* | 1*    | 12.5* | 1     | 12.5  | ns   |
| <sup>t</sup> PZL   | OE      | Y        |                           |                | 6.8*     | 10.5* | 1*    | 12.5* | 1     | 12.5  | 115  |
| <sup>t</sup> PHZ   | OE      | Y        | C <sub>I</sub> = 15 pF    |                | 6.8*     | 10.5* | 1*    | 12.5* | 1     | 12.5  | ns   |
| <sup>t</sup> PLZ   | ÛE      |          | I                         |                |          | 6.8*  | 10.5* | 1*    | 12.5* | 1     | 12.5 |
| <sup>t</sup> PLH   | A       | Y        | C <sub>1</sub> = 50 pF    |                | 7.3      | 10.5  | 1     | 12    | 1     | 12    | ns   |
| <sup>t</sup> PHL   |         | I        | CL = 30 pP                |                | 7.3      | 10.5  | 1     | 12    | 1     | 12    | 115  |
| <sup>t</sup> PZH   | OE      | Y        | $C_{\rm L} = 50  \rm pE$  |                | 8        | 14    | 1     | 16    | 1     | 16    | ns   |
| t <sub>PZL</sub>   | ÛE      | Y        | Y $C_{L} = 50 \text{ pF}$ |                | 8        | 14    | 1     | 16    | 1     | 16    | 115  |
| <sup>t</sup> PHZ   | OE      | Y        | C <sub>L</sub> = 50 pF    |                | 8        | 15.4  | 1     | 17.5  | 1     | 17.5  | ns   |
| <sup>t</sup> PLZ   | UE      | 1        |                           |                | 8        | 15.4  | 1     | 17.5  | 1     | 17.5  | 115  |
| <sup>t</sup> sk(o) |         |          | C <sub>L</sub> = 50 pF    |                |          | 1.5** |       |       |       | 1.5   | ns   |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested. \*\* On products compliant to MIL-PRF-38535, this parameter does not apply.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

| DADAMETER          | FROM    | то                 | LOAD                     | T,                     | <b>₄ = 25°C</b> | ;          | SN54A | HC540 | SN74A | HC540 |      |    |     |
|--------------------|---------|--------------------|--------------------------|------------------------|-----------------|------------|-------|-------|-------|-------|------|----|-----|
| PARAMETER          | (INPUT) | (OUTPUT)           | CAPACITANCE              | MIN                    | TYP             | MAX        | MIN   | MAX   | MIN   | MAX   | UNIT |    |     |
| <sup>t</sup> PLH   | А       | Y                  | C <sub>I</sub> = 15 pF   |                        | 3.7*            | 5*         | 1*    | 6*    | 1     | 6     | ns   |    |     |
| <sup>t</sup> PHL   | A       | Т                  | CL = 15 pr               |                        | 3.7*            | 5*         | 1*    | 6*    | 1     | 6     | 115  |    |     |
| <sup>t</sup> PZH   | OE      | Y                  | C <sub>I</sub> = 15 pF   |                        | 4.7*            | 7.2*       | 1*    | 8.5*  | 1     | 8.5   | ns   |    |     |
| <sup>t</sup> PZL   | OE      | Т                  | CL = 15 pr               |                        | 4.7*            | 7.2*       | 1*    | 8.5*  | 1     | 8.5   | 115  |    |     |
| <sup>t</sup> PHZ   | ŌĒ      | Y                  | Y                        | C <sub>I</sub> = 15 pF |                 | 4.5*       | 6.8*  | 1*    | 8*    | 1     | 8    | ns |     |
| <sup>t</sup> PLZ   |         |                    |                          | •                      | •               | 0 <u> </u> |       | 4.5*  | 6.8*  | 1*    | 8*   | 1  | 8   |
| <sup>t</sup> PLH   | А       | Y                  | C <sub>1</sub> = 50 pF   |                        | 5.2             | 7          | 1     | 8     | 1     | 8     | ns   |    |     |
| <sup>t</sup> PHL   | A       | I                  | CL = 30 pr               |                        | 5.2             | 7          | 1     | 8     | 1     | 8     | 115  |    |     |
| <sup>t</sup> PZH   | OE      | Y                  | $C_{\rm L} = 50  \rm pE$ |                        | 6.2             | 9.2        | 1     | 10.5  | 1     | 10.5  | ns   |    |     |
| <sup>t</sup> PZL   | ÛE      | Y $C_{L} = 50  pF$ | CL = 50 pr               |                        | 6.2             | 9.2        | 1     | 10.5  | 1     | 10.5  | 115  |    |     |
| <sup>t</sup> PHZ   | OE      | Y                  | C <sub>I</sub> = 50 pF   |                        | 6               | 8.8        | 1     | 10    | 1     | 10    | ns   |    |     |
| <sup>t</sup> PLZ   | UE      | ſ                  |                          |                        | 0 <u> </u>      |            | 6     | 8.8   | 1     | 10    | 1    | 10 | 115 |
| <sup>t</sup> sk(o) |         |                    | C <sub>L</sub> = 50 pF   |                        |                 | 1**        |       |       |       | 1     | ns   |    |     |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

\*\* On products compliant to MIL-PRF-38535, this parameter does not apply.



# noise characteristics, V<sub>CC</sub> = 5 V, C<sub>L</sub> = 50 pF, T<sub>A</sub> = 25°C (see Note 4)

| HC540 | UNIT |
|-------|------|
| MAX   | UNIT |
| 0.8   | V    |
| -0.8  | V    |
|       | V    |
|       | V    |
| 1.5   | V    |
|       | 0.8  |

NOTE 4: Characteristics are for surface-mount packages only.

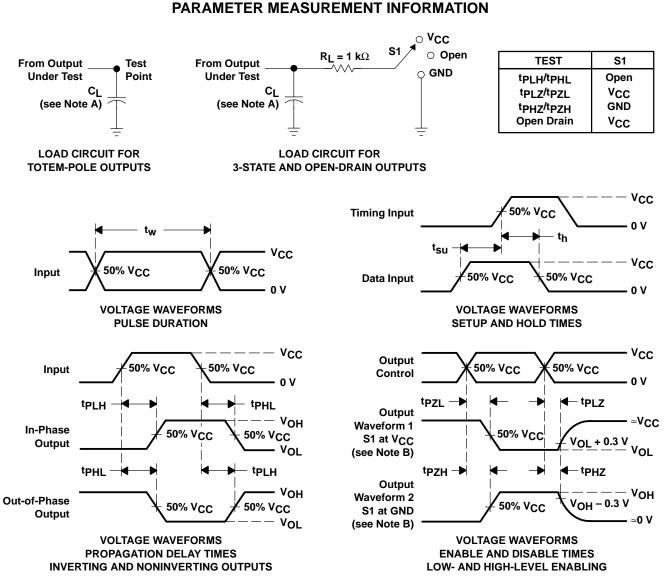
### operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

|                 | PARAMETER                     | TEST CO  | ONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|----------|-----------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | No load, | f = 1 MHz | 12  | pF   |



SN54AHC540, SN74AHC540 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms



9-Oct-2007

#### **PACKAGING INFORMATION**

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| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | n MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|--------------------------------|
| 5962-9685001Q2A  | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                       | POST-PLATE       | N / A for Pkg Type             |
| 5962-9685001QRA  | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                       | A42 SNPB         | N / A for Pkg Type             |
| 5962-9685001QSA  | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                       | A42              | N / A for Pkg Type             |
| SN74AHC540DBLE   | OBSOLETE              | SSOP            | DB                 | 20   |                | TBD                       | Call TI          | Call TI                        |
| SN74AHC540DBR    | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DBRE4  | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DBRG4  | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DGVR   | ACTIVE                | TVSOP           | DGV                | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DGVRE4 | ACTIVE                | TVSOP           | DGV                | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DGVRG4 | ACTIVE                | TVSOP           | DGV                | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DW     | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DWE4   | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DWG4   | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DWR    | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DWRE4  | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540DWRG4  | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540N      | ACTIVE                | PDIP            | Ν                  | 20   | 20             | Pb-Free<br>(RoHS)         | CU NIPDAU        | N / A for Pkg Type             |
| SN74AHC540NE4    | ACTIVE                | PDIP            | Ν                  | 20   | 20             | Pb-Free<br>(RoHS)         | CU NIPDAU        | N / A for Pkg Type             |
| SN74AHC540NSR    | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540NSRE4  | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540NSRG4  | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540PW     | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540PWE4   | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540PWG4   | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540PWLE   | OBSOLETE              | TSSOP           | PW                 | 20   |                | TBD                       | Call TI          | Call TI                        |
| SN74AHC540PWR    | ACTIVE                | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |
| SN74AHC540PWRE4  | ACTIVE                | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM             |

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74AHC540PWRG4  | ACTIVE                | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SNJ54AHC540FK    | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                       | POST-PLATE       | N / A for Pkg Type           |
| SNJ54AHC540J     | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                       | A42 SNPB         | N / A for Pkg Type           |
| SNJ54AHC540W     | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                       | A42              | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

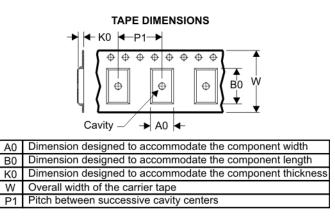
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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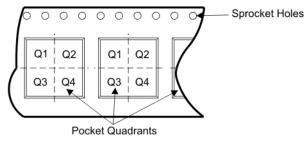
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#### TAPE AND REEL BOX INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device         | Package | Pins | Site    | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|---------|------|---------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| SN74AHC540DBR  | DB      | 20   | SITE 41 | 330                      | 16                    | 8.2     | 7.5     | 2.5     | 12         | 16        | Q1               |
| SN74AHC540DGVR | DGV     | 20   | SITE 41 | 330                      | 12                    | 7.0     | 5.6     | 1.6     | 8          | 12        | Q1               |
| SN74AHC540DWR  | DW      | 20   | SITE 41 | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| SN74AHC540PWR  | PW      | 20   | SITE 41 | 330                      | 16                    | 6.95    | 7.1     | 1.6     | 8          | 16        | Q1               |



# PACKAGE MATERIALS INFORMATION

12-Feb-2008



| Device         | Package | Pins | Site    | Length (mm) | Width (mm) | Height (mm) |
|----------------|---------|------|---------|-------------|------------|-------------|
| SN74AHC540DBR  | DB      | 20   | SITE 41 | 346.0       | 346.0      | 33.0        |
| SN74AHC540DGVR | DGV     | 20   | SITE 41 | 346.0       | 346.0      | 29.0        |
| SN74AHC540DWR  | DW      | 20   | SITE 41 | 346.0       | 346.0      | 41.0        |
| SN74AHC540PWR  | PW      | 20   | SITE 41 | 346.0       | 346.0      | 33.0        |

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20



MLCC006B - OCTOBER 1996

#### FK (S-CQCC-N\*\*)

#### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

#### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

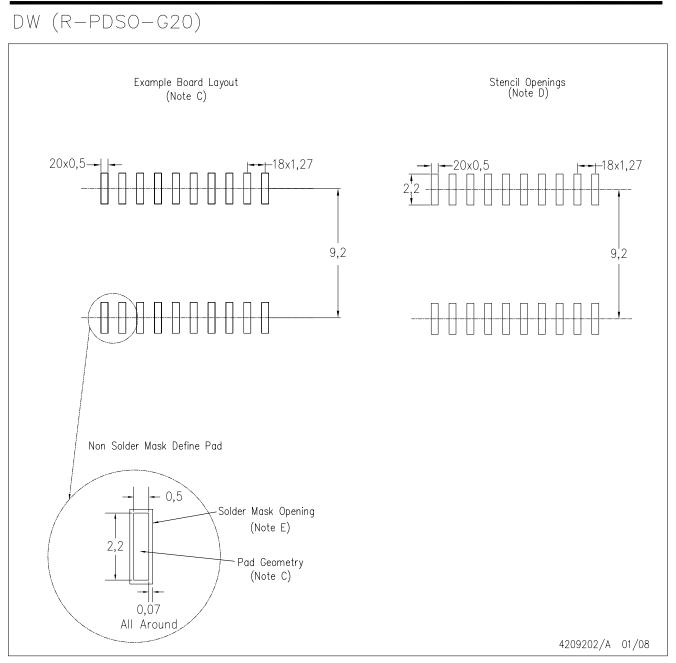
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



## LAND PATTERN



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

### DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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